# Advanced Chipset and Modem Technology to Increase Wireless Capabilities across Advanced Tablets and Smartphones

LAS VEGAS, /PRNewswire-FirstCall/ -- Qualcomm Inc. will be demonstrating its chipset and modem technology utilized in the next generation of connected devices for consumer electronics at the 2011 International CES, January 6-9 in Las Vegas. The Company is working with leading manufacturers and developers to showcase several new tablets and smartphones powered by Qualcomm's award winning Snapdragon™ family of processors. Attendees can see these newest innovations at the Qualcomm exhibit, located in the Las Vegas Convention Center, South Hall, Upper Level #30313. The expanding Snapdragon portfolio includes dual-CPU chips with high-performance processing and full HD graphic capabilities for the next generation of tablets and devices, as well as the only LTE and HSPA+ multi-mode chipsets. Qualcomm also continues its legacy of innovation and connectivity with exhibits featuring next-generation modem developments, LTE-enabled mobile devices, and new 4G handsets for LTE and HSPA+ networks. "Leading manufacturers and developers continue to turn to Qualcomm to help navigate and solve today's wireless complexities and bring devices to market as quickly as possible," said Steve Mollenkopf, executive vice president and group president, Qualcomm. "Qualcomm's integration of hardware and software creates a better user experience with longer battery life and smaller devices. Our evolving 3G and 4G technologies support the complex transition to LTE to meet rising consumer expectations for their wireless experiences." With its chipset portfolio that supports the Android™ platform, Qualcomm has helped launch more than five times as many Android devices as any other chipset provider, including larger-display devices such as tablets and smartbooks, as well as entry-level smartphones. Microsoft chose Qualcomm's Snapdragon chipset to power its Windows Phone 7 launch devices this year, partnering with multiple OEMs and carriers worldwide. There are currently more than 55 Snapdragon-powered devices on the market and 125 Snapdragon device designs in process, including more than 10 OEMs designing tablets. "Qualcomm's wireless technology makes them the right mobile Internet devices partner for Lenovo as we continue to bring new, innovative devices, such as the LePad tablet, to consumers," said Liu Jun, senior vice president at Lenovo. "We look forward to integrating Qualcomm's high-performance Snapdragon processor into future media-rich, connected devices." "We are excited to announce at CES that our 7" Android tablet is powered by Qualcomm's dual-core Snapdragon processor," said Jim Wong, senior corporate vice president and president of ITGO for Acer. "Running Android's Gingerbread, Acer's 7" tablet brings a media-rich user experience and all-day battery life to consumers on the go. We look forward to our continued collaboration with Qualcomm to bring innovative, top performing devices to consumers around the world."

**Source URL (retrieved on *12/19/2013 - 9:12am*):**

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